- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- Package Options Include Plastic Small-Outline (SOIC) and Shrink Small-Outline (SSOP) Packages, Ceramic Chip Carriers, and Plastic and Ceramic DIPs

description

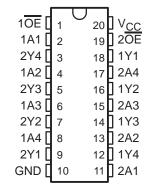
These octal buffers and line drivers are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. Taken together with the 'F241 and 'F244, these devices provide the choice of selected combinations of inverting and noninverting outputs, symmetrical \overline{OE} (active-low output-enable) inputs, and complementary \overline{OE} and \overline{OE} inputs.

The 'F240 is organized as two 4-bit buffers/line drivers with separate output enable (\overline{OE}) inputs. When \overline{OE} is low, the device passes data from the A inputs to the Y outputs. When \overline{OE} is high, the outputs are in the high-impedance state.

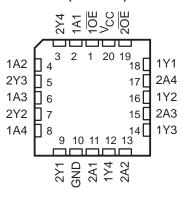
The SN74F240 is available in Tl's shrink small-outline package (DB), which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed-circuit-board area.

The SN54F240 is characterized for operation over the full military temperature range of -55° C to 125°C. The SN74F240 is characterized for operation from 0°C to 70°C.

SN54F240 . . . J PACKAGE SN74F240 . . . DB, DW, OR N PACKAGE (TOP VIEW)



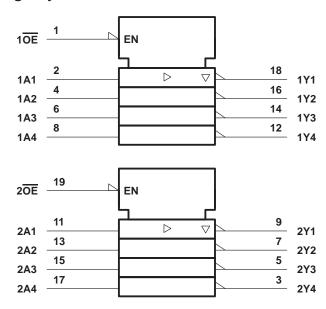
SN54F240 ... FK PACKAGE (TOP VIEW)



FUNCTION TABLE (each buffer)

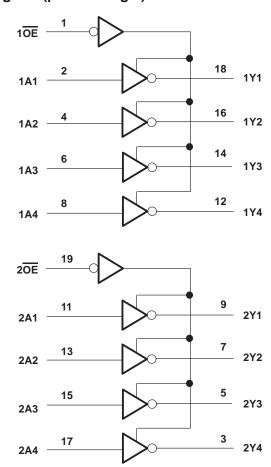
| INP | JTS | OUTPUT |
|-----|-----|--------|
| OE | Α | Υ |
| L | Н | L |
| L | L | Н |
| Н | Χ | Z |

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

| Supply voltage range, V _{CC} | |
|--|--------------------------|
| Input current range | |
| Voltage range applied to any output in the disabled or power-off state | 0.5 V to 5.5 V |
| Voltage range applied to any output in the high state | 0.5 V to V _{CC} |
| Current into any output in the low state: SN54F240 | 96 mÅ |
| SN74F240 | 128 mA |
| Operating free-air temperature range: SN54F240 | –55°C to 125°C |
| SN74F240 | 0°C to 70°C |
| Storage temperature range | −65°C to 150°C |

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.



SDFS061A - D2932, MARCH 1987 - REVISED OCTOBER 1993

recommended operating conditions

| | | S | N54F240 |) | SN74F240 | |) | UNIT |
|-----------------|--------------------------------|-----|---------|------|----------|-----|-------------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | UNIT |
| Vcc | Supply voltage | 4.5 | 5 | 5.5 | 4.5 | 5 | 5.5 | V |
| VIH | High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} | Low-level input voltage | | | 0.8 | | | 0.8 | V |
| ΙΙΚ | Input clamp current | | | -18 | | | -18 | mA |
| IOH | High-level output current | | | - 12 | | | – 15 | mA |
| lOL | Low-level output current | | | 48 | | | 64 | mA |
| TA | Operating free-air temperature | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETED | T | OT CONDITIONS | S | N54F240 | 0 | S | N74F240 | 0 | UNIT | |
|------------------|----------------------------|---------------------------|------|---------|------------|------|---------|------------|------|--|
| PARAMETER | l les | ST CONDITIONS | MIN | TYP† | MAX | MIN | TYP† | MAX | UNII | |
| VIK | V _{CC} = 4.5 V, | $I_{I} = -18 \text{ mA}$ | | | -1.2 | | | -1.2 | V | |
| | | $I_{OH} = -3 \text{ mA}$ | 2.4 | 3.3 | | 2.4 | 3.3 | | | |
| Va., | V _{CC} = 4.5 V | $I_{OH} = -12 \text{ mA}$ | 2 | 3.2 | | | | | V | |
| VOH | | $I_{OH} = -15 \text{ mA}$ | | | | 2 | 3.1 | | V | |
| | $V_{CC} = 4.75 \text{ V},$ | $I_{OH} = -3 \text{ mA}$ | | | | 2.7 | | | | |
| | V _{CC} = 4.5 V | $I_{OL} = 48 \text{ mA}$ | | 0.38 | 0.55 | | | | V | |
| VOL | VCC = 4.5 V | $I_{OL} = 64 \text{ mA}$ | | | | | 0.42 | 0.55 | V | |
| IOZH | $V_{CC} = 5.5 \text{ V},$ | $V_0 = 2.7 \text{ V}$ | | | 50 | | | 50 | μΑ | |
| lozL | V _{CC} = 5.5 V, | V _O = 0.5 V | | | -50 | | | -50 | μΑ | |
| lį | V _{CC} = 5.5 V, | V _I = 7 V | | | 0.1 | | | 0.1 | mA | |
| lіН | V _{CC} = 5.5 V, | V _I = 2.7 V | | | 20 | | | 20 | μΑ | |
| I _Ι Γ | V _{CC} = 5.5 V, | V _I = 0.5 V | | | – 1 | | | – 1 | mA | |
| los [‡] | V _{CC} = 5.5 V, | V _O = 0 | -100 | | -225 | -100 | | -225 | mA | |
| | V _{CC} = 5.5 V | Outputs high | | 19 | 29 | | 19 | 29 | | |
| ICC | | Outputs low | | 50 | 75 | | 50 | 75 | mA | |
| | | Outputs disabled | | 42 | 63 | | 42 | 63 | | |

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[‡] Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

switching characteristics (see Note 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | C _I R _I | CC = 5 V _ = 50 p _ = 500 s _ = 25°C | F, Ω, | C _L R _L | = 50 pF = 500 Ω | | V, | UNIT |
|------------------|-----------------|----------------|----------------------------------|---|----------|----------------------------------|--------------------|------|------|------|
| | | | | ′F240 | | SN54 | F240 | SN74 | F240 | |
| | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| ^t PLH | Δ Δ | Y | 2.2 | 4.7 | 7 | 2.2 | 9 | 2.2 | 8 | ns |
| t _{PHL} | Any A | Y | 1.2 | 3.1 | 4.7 | 1.2 | 6 | 1.2 | 5.7 | |
| ^t PZH | ŌĒ | Y | 1.2 | 3.1 | 5.3 | 1.2 | 6.7 | 1.2 | 6.1 | ns |
| t _{PZL} | OE | Ť | 3.2 | 6.5 | 9 | 3.2 | 10.5 | 3.2 | 10 | 115 |
| ^t PHZ | ŌĒ | Y | 1.2 | 3.6 | 5.3 | 1.2 | 6.5 | 1.2 | 6.3 | ns |
| t _{PLZ} |) L | 1 | 1.2 | 5.6 | 8 | 1.2 | 12.5 | 1.2 | 9.5 | 115 |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. NOTE 2: Load circuits and waveforms are shown in Section 1.



www.ti.com

7-Oct-2025

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material | MSL rating/ Peak reflow | Op temp (°C) | Part marking (6) |
|-----------------------|------------|---------------|----------------|-----------------------|-----------------|-------------------------------|----------------------------|--------------|--|
| 5962-9758501Q2A | Active | Production | LCCC (FK) 20 | 55 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962- 9758501Q2A SNJ54F 240FK |
| 5962-9758501QRA | Active | Production | CDIP (J) 20 | 20 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-9758501QR A SNJ54F240J |
| 5962-9758501QSA | Active | Production | CFP (W) 20 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-9758501QS A SNJ54F240W |
| JM38510/33201B2A | Active | Production | LCCC (FK) 20 | 55 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | JM38510/ 33201B2A |
| JM38510/33201B2A.A | Active | Production | LCCC (FK) 20 | 55 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | JM38510/ 33201B2A |
| JM38510/33201BRA | Active | Production | CDIP (J) 20 | 20 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | JM38510/ 33201BRA |
| JM38510/33201BRA.A | Active | Production | CDIP (J) 20 | 20 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | JM38510/ 33201BRA |
| JM38510/33201BSA | Active | Production | CFP (W) 20 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | JM38510/ 33201BSA |
| JM38510/33201BSA.A | Active | Production | CFP (W) 20 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | JM38510/ 33201BSA |
| M38510/33201B2A | Active | Production | LCCC (FK) 20 | 55 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | JM38510/ 33201B2A |
| M38510/33201BRA | Active | Production | CDIP (J) 20 | 20 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | JM38510/ 33201BRA |
| M38510/33201BSA | Active | Production | CFP (W) 20 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | JM38510/ 33201BSA |
| SN54F240J | Active | Production | CDIP (J) 20 | 20 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | SN54F240J |
| SN54F240J.A | Active | Production | CDIP (J) 20 | 20 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | SN54F240J |
| SN74F240DW | Obsolete | Production | SOIC (DW) 20 | - | - | Call TI | Call TI | 0 to 70 | F240 |
| SN74F240DW.B | Obsolete | Production | SOIC (DW) 20 | - | - | Call TI | Call TI | 0 to 70 | F240 |
| SN74F240DWR | Active | Production | SOIC (DW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | F240 |





www.ti.com

7-Oct-2025

| Orderable part number | Status (1) | Material type | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material | MSL rating/ Peak reflow | Op temp (°C) | Part marking (6) |
|-----------------------|------------|---------------|----------------|-----------------------|-----------------|-------------------------------|----------------------------|--------------|--|
| SN74F240DWR.A | Active | Production | SOIC (DW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | F240 |
| SN74F240DWR.B | Active | Production | SOIC (DW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | F240 |
| SN74F240N | Active | Production | PDIP (N) 20 | 20 TUBE | Yes | NIPDAU | N/A for Pkg Type | 0 to 70 | SN74F240N |
| SN74F240N.A | Active | Production | PDIP (N) 20 | 20 TUBE | Yes | NIPDAU | N/A for Pkg Type | 0 to 70 | SN74F240N |
| SN74F240NSR | Active | Production | SOP (NS) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 74F240 |
| SN74F240NSR.A | Active | Production | SOP (NS) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 74F240 |
| SNJ54F240FK | Active | Production | LCCC (FK) 20 | 55 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962- 9758501Q2A SNJ54F 240FK |
| SNJ54F240FK.A | Active | Production | LCCC (FK) 20 | 55 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962- 9758501Q2A SNJ54F 240FK |
| SNJ54F240J | Active | Production | CDIP (J) 20 | 20 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-9758501QR A SNJ54F240J |
| SNJ54F240J.A | Active | Production | CDIP (J) 20 | 20 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-9758501QR A SNJ54F240J |
| SNJ54F240W | Active | Production | CFP (W) 20 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-9758501QS A SNJ54F240W |
| SNJ54F240W.A | Active | Production | CFP (W) 20 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-9758501QS A SNJ54F240W |

⁽¹⁾ Status: For more details on status, see our product life cycle.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

PACKAGE OPTION ADDENDUM

www.ti.com 7-Oct-2025

(4) Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54F240, SN74F240:

Catalog: SN74F240

Military: SN54F240

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

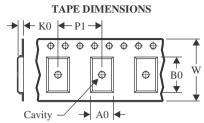
• Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

www.ti.com 23-Jul-2025

TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74F240DWR | SOIC | DW | 20 | 2000 | 330.0 | 24.4 | 10.8 | 13.3 | 2.7 | 12.0 | 24.0 | Q1 |
| SN74F240NSR | SOP | NS | 20 | 2000 | 330.0 | 24.4 | 8.4 | 13.0 | 2.5 | 12.0 | 24.0 | Q1 |

PACKAGE MATERIALS INFORMATION

www.ti.com 23-Jul-2025

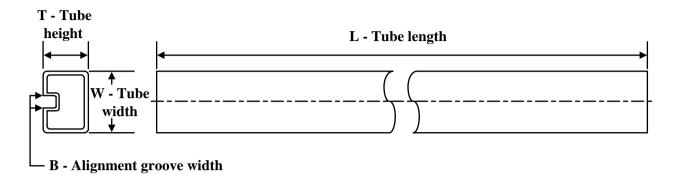


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74F240DWR | SOIC | DW | 20 | 2000 | 356.0 | 356.0 | 45.0 |
| SN74F240NSR | SOP | NS | 20 | 2000 | 356.0 | 356.0 | 45.0 |

www.ti.com 23-Jul-2025

TUBE



*All dimensions are nominal

| | 1 | 1 | | 1 | | î | | |
|--------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
| 5962-9758501Q2A | FK | LCCC | 20 | 55 | 506.98 | 12.06 | 2030 | NA |
| 5962-9758501QSA | W | CFP | 20 | 25 | 506.98 | 26.16 | 6220 | NA |
| JM38510/33201B2A | FK | LCCC | 20 | 55 | 506.98 | 12.06 | 2030 | NA |
| JM38510/33201B2A.A | FK | LCCC | 20 | 55 | 506.98 | 12.06 | 2030 | NA |
| JM38510/33201BSA | W | CFP | 20 | 25 | 506.98 | 26.16 | 6220 | NA |
| JM38510/33201BSA.A | W | CFP | 20 | 25 | 506.98 | 26.16 | 6220 | NA |
| M38510/33201B2A | FK | LCCC | 20 | 55 | 506.98 | 12.06 | 2030 | NA |
| M38510/33201BSA | W | CFP | 20 | 25 | 506.98 | 26.16 | 6220 | NA |
| SN74F240N | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |
| SN74F240N.A | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |
| SNJ54F240FK | FK | LCCC | 20 | 55 | 506.98 | 12.06 | 2030 | NA |
| SNJ54F240FK.A | FK | LCCC | 20 | 55 | 506.98 | 12.06 | 2030 | NA |
| SNJ54F240W | W | CFP | 20 | 25 | 506.98 | 26.16 | 6220 | NA |
| SNJ54F240W.A | W | CFP | 20 | 25 | 506.98 | 26.16 | 6220 | NA |

14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



INSTRUMENTS www.ti.com

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOIC



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.

 D. Index point is provided on cap for terminal identification only.

 E. Falls within Mil—Std 1835 GDFP2—F20



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2025. Texas Instruments Incorporated